

### Features

- Low on-voltage drop ( $V_{CE(sat)}$ )
- High current capability

### Applications

- Light dimmer
- Static relays
- Motor drive

### Description

This IGBT utilizes the advanced PowerMESH™ process featuring extremely low on-state voltage drop in low-frequency working conditions (up to 1 kHz).

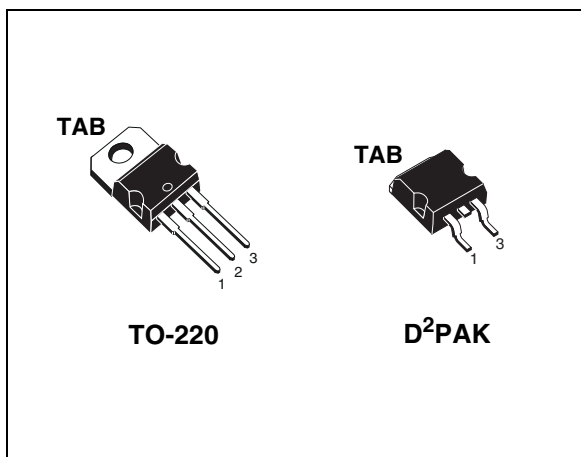


Figure 1. Internal schematic diagram

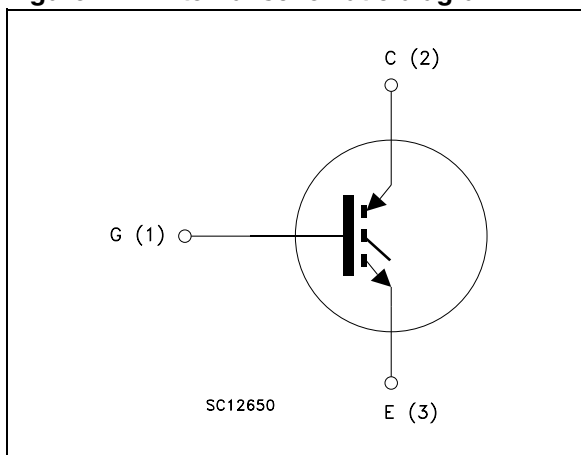


Table 1. Device summary

Order codes	Marking	Package	Packaging
STGB10NB60ST4	GB10NB60S	D <sup>2</sup> PAK	Tape and reel
STGP10NB60S	GP10NB60S	TO-220	Tube

# Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage ( $V_{GE} = 0$ )	600	V
$I_C^{(1)}$	Continuous collector current at $T_C = 25\text{ °C}$	29	A
$I_C^{(1)}$	Continuous collector current at $T_C = 100\text{ °C}$	16	A
$I_{CL}^{(2)}$	Turn-off latching current	20	A
$I_{CP}^{(3)}$	Pulsed collector current	80	A
$V_{GE}$	Gate-emitter voltage	$\pm 20$	V
$P_{TOT}$	Total dissipation at $T_C = 25\text{ °C}$	80	W
$T_j$	Operating junction temperature	- 55 to 150	°C

1. Calculated according to the iterative formula

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2.  $V_{clamp} = 80\%$  of  $V_{CES}$ ,  $T_j = 150\text{ °C}$ ,  $R_G = 1k\Omega$ ,  $V_{GE} = 15\text{ V}$   
 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	1.56	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	°C/W

## 2 Electrical characteristics

( $T_j = 25\text{ °C}$  unless otherwise specified)

**Table 4. Static**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ( $V_{GE} = 0$ )	$I_C = 250\ \mu\text{A}$	600			V
$V_{(BR)ECS}$	Emitter-collector breakdown voltage ( $V_{GE} = 0$ )	$I_C = 1\ \text{mA}$	20			V
$I_{GES}$	Gate-emitter leakage current ( $V_{CE} = 0$ )	$V_{GE} = \pm 20\ \text{V}$			$\pm 100$	nA
$I_{CES}$	Collector cut-off current ( $V_{GE} = 0$ )	$V_{CE} = 600\ \text{V}$ $V_{CE} = 600\ \text{V}, T_j = 125\text{ °C}$			10 100	$\mu\text{A}$ $\mu\text{A}$
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250\ \mu\text{A}$	2.5		5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\ \text{V}, I_C = 5\ \text{A}$ $V_{GE} = 15\ \text{V}, I_C = 10\ \text{A}$ $V_{GE} = 15\ \text{V}, I_C = 10\ \text{A}, T_j = 125\text{ °C}$		1.15 1.35 1.25	1.75	V
$g_{fs}^{(1)}$	Forward transconductance	$V_{CE} = 15\ \text{V}, I_C = 10\ \text{A}$	5			S

1. Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{ies}$	Input capacitance			610		pF
$C_{oes}$	Output capacitance	$V_{CE} = 25\ \text{V}, f = 1\ \text{MHz}, V_{GE} = 0$	-	65	-	pF
$C_{res}$	Reverse transfer capacitance					
$Q_g$	Total gate charge	$V_{CE} = 400\ \text{V}, I_C = 10\ \text{A},$ $V_{GE} = 15\ \text{V}$ (see Figure 17)	-	33	-	nC

**Table 6. Switching on/off (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 480\text{ V}, I_C = 10\text{ A}$		0.7		$\mu\text{s}$
$t_r$	Current rise time	$R_G = 1\text{ k}\Omega, V_{GE} = 15\text{ V}$	-	0.46	-	$\mu\text{s}$
$(di/dt)_{on}$	Turn-on current slope	(see Figure 16)		8		$\text{A}/\mu\text{s}$
$t_r(V_{off})$	Off voltage rise time	$V_{CC} = 480\text{ V}, I_C = 10\text{ A}$		2.2		
$t_{d(off)}$	Turn-off delay time	$R_G = 1\text{ k}\Omega, V_{GE} = 15\text{ V}$	-	1.2	-	$\mu\text{s}$
$t_f$	Current fall time	(see Figure 16)		1.2		
$t_r(V_{off})$	Off voltage rise time	$V_{CC} = 480\text{ V}, I_C = 10\text{ A}$		3.8		
$t_{d(off)}$	Turn-off delay time	$R_G = 1\text{ k}\Omega, V_{GE} = 15\text{ V},$ $T_j = 125\text{ }^\circ\text{C}$	-	1.2	-	$\mu\text{s}$
$t_f$	Current fall time	(see Figure 16)		1.9		

**Table 7. Switching energy (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}^{(1)}$	Turn-on switching losses	$V_{CC} = 480\text{ V}, I_C = 10\text{ A}$		0.6		mJ
$E_{off}^{(2)}$	Turn-off switching losses	$R_G = 1\text{ k}\Omega, V_{GE} = 15\text{ V}$	-	5	-	mJ
$E_{ts}$	Total switching losses	(see Figure 16)		5.6		mJ
$E_{off}^{(2)}$	Turn-off switching losses	$V_{CC} = 480\text{ V}, I_C = 10\text{ A}$ $R_G = 1\text{ k}\Omega, V_{GE} = 15\text{ V},$ $T_j = 125\text{ }^\circ\text{C}$	-	8	-	mJ
		(see Figure 16)				

1.  $E_{on}$  is the turn-on losses when a typical diode is used in the test circuit. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25°C and 125°C).
2. Turn-off losses include also the tail of the collector current.

## 2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

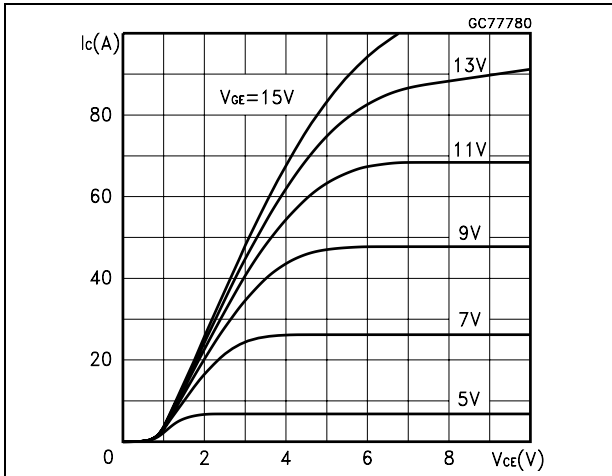


Figure 3. Transfer characteristics

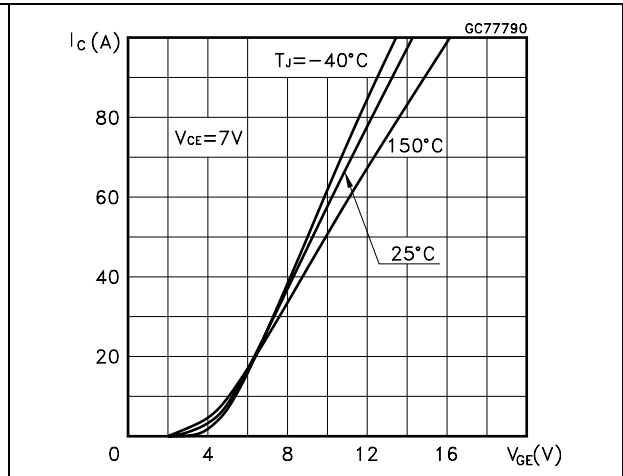


Figure 4. Transconductance

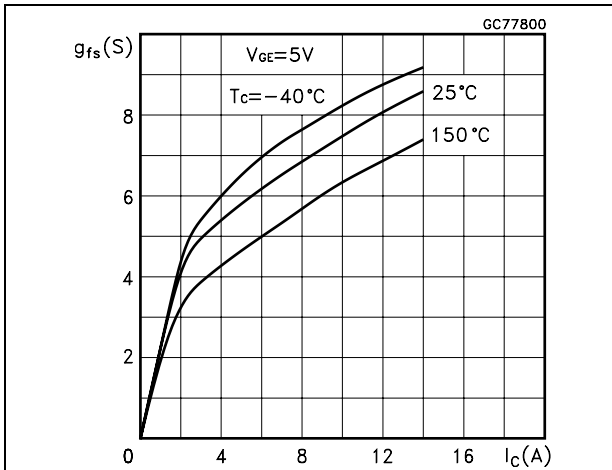


Figure 5. Collector-emitter on voltage vs. temperature

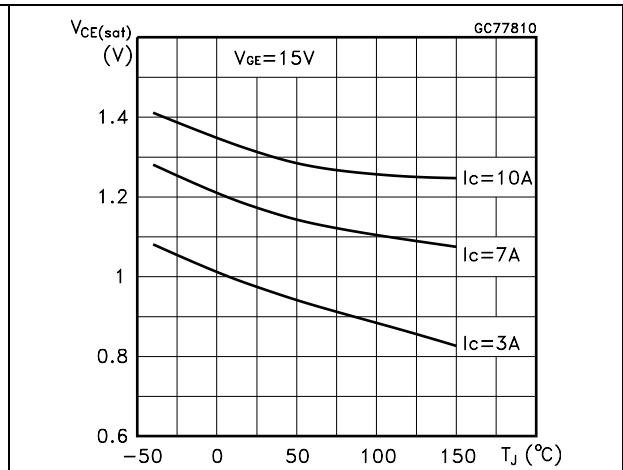


Figure 6. Collector-emitter on voltage vs. collector current

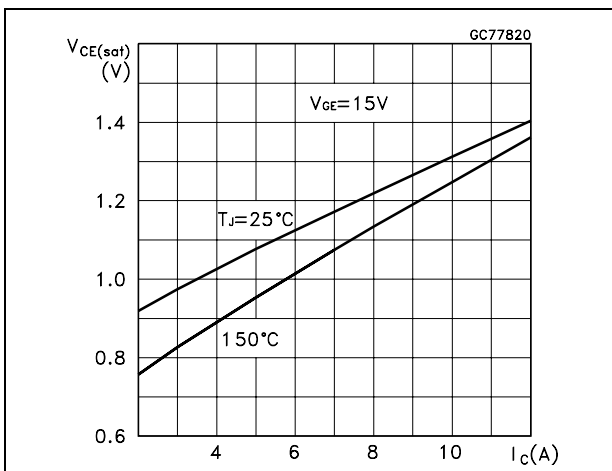
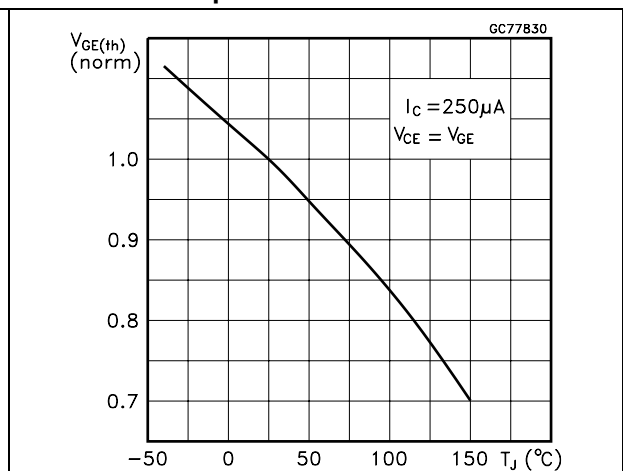
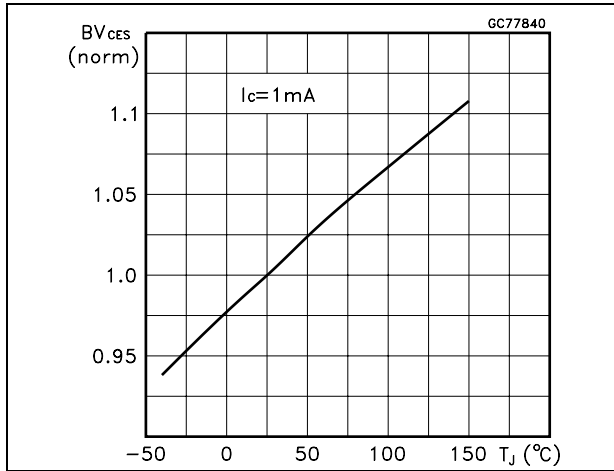


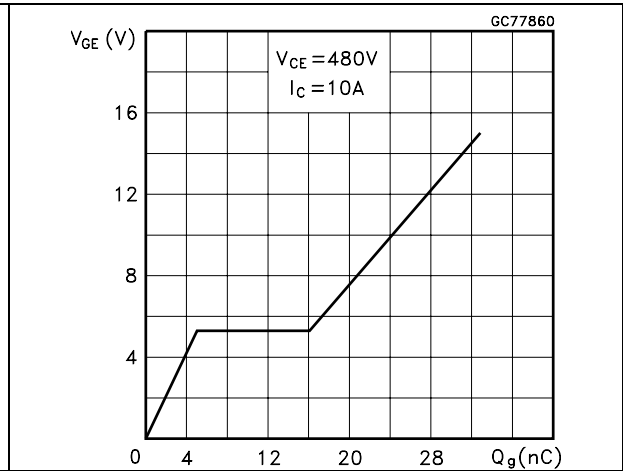
Figure 7. Normalized gate threshold vs. temperature



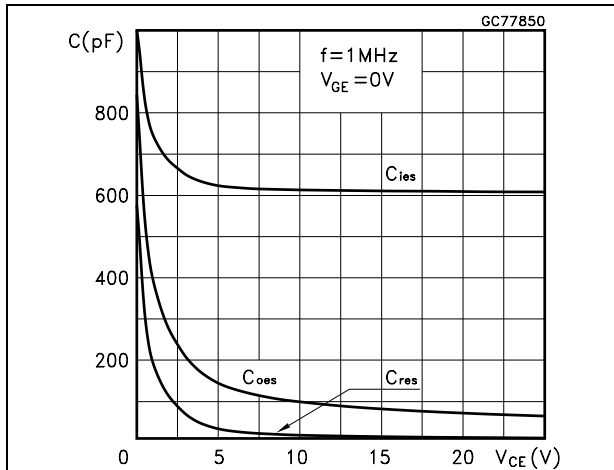
**Figure 8. Normalized breakdown voltage vs. temperature**



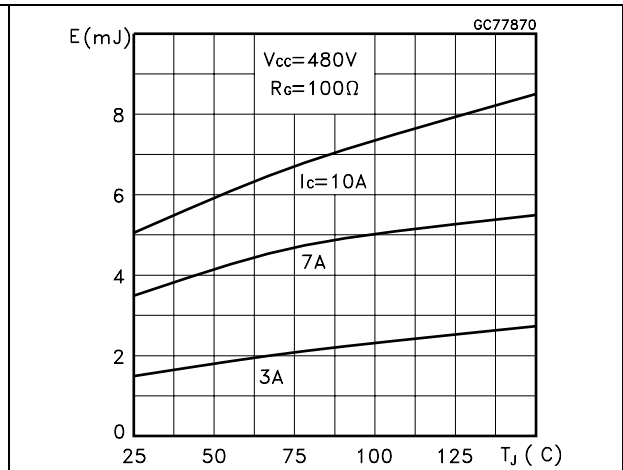
**Figure 9. Gate charge vs. gate-emitter voltage**



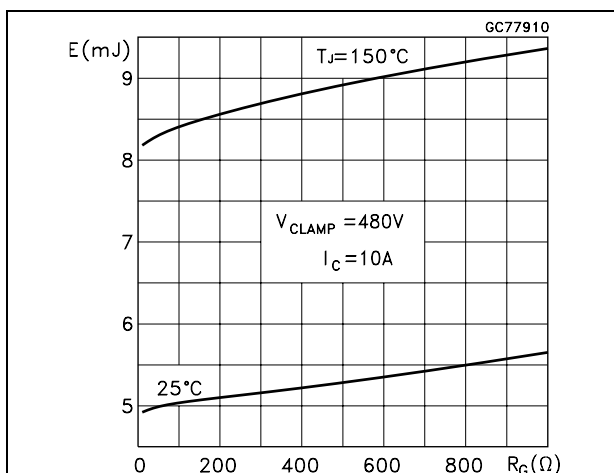
**Figure 10. Capacitance variations**



**Figure 11. Switching losses vs. temperature**



**Figure 12. Switching losses vs. gate resistance**



**Figure 13. Switching losses vs. collector current**

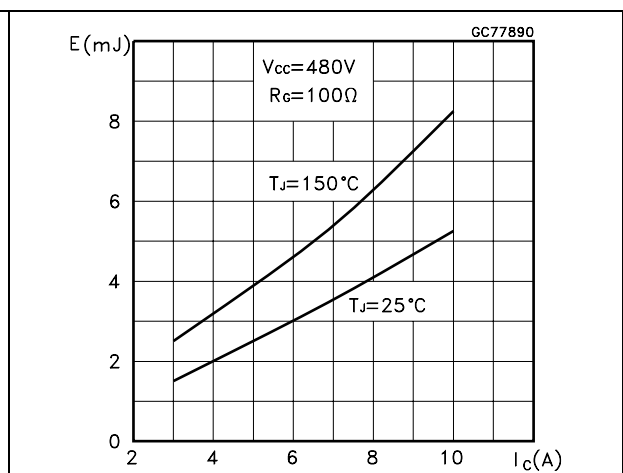
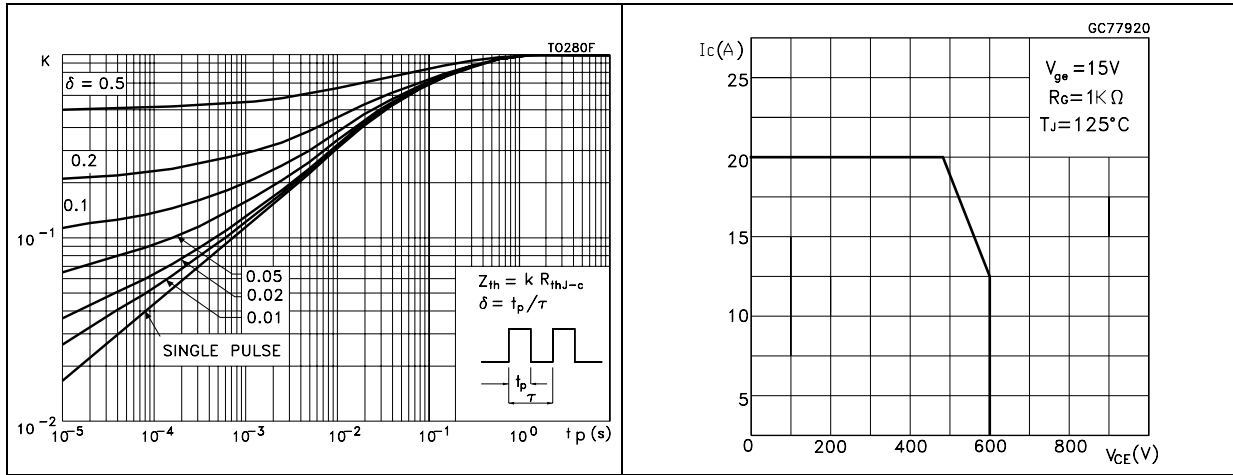


Figure 14. Thermal impedance for TO-220 and D<sup>2</sup>PAK

Figure 15. Turn-off SOA





### 3 Test circuits

Figure 16. Test circuit for inductive load switching

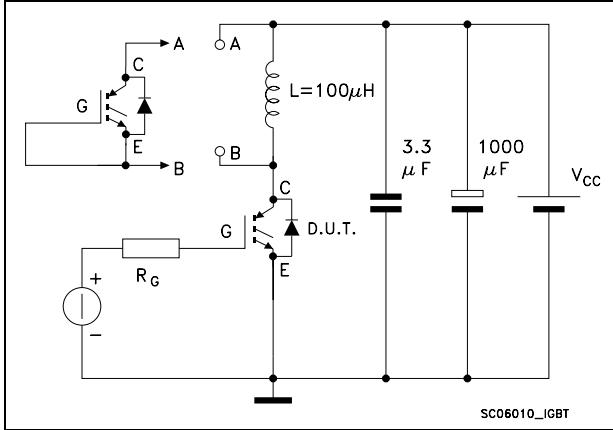


Figure 17. Gate charge test circuit

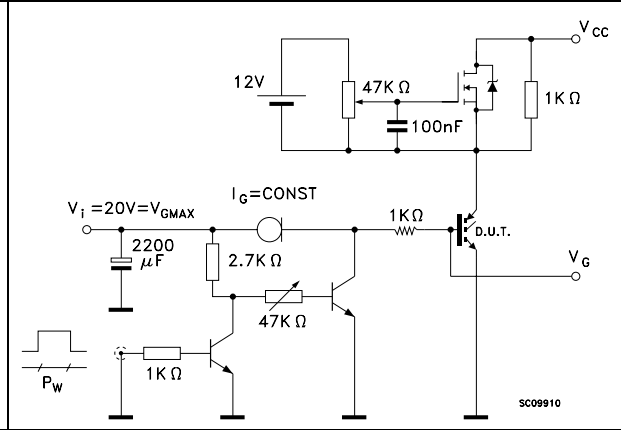
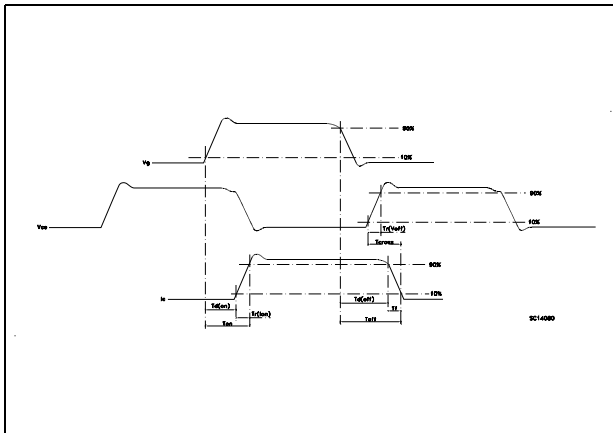


Figure 18. Switching waveforms



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

Table 8. D<sup>2</sup>PAK (TO-263) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
E	10		10.40
E1	8.50		
e		2.54	
e1	4.88		5.28
H	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

Figure 19. D<sup>2</sup>PAK (TO-263) drawing

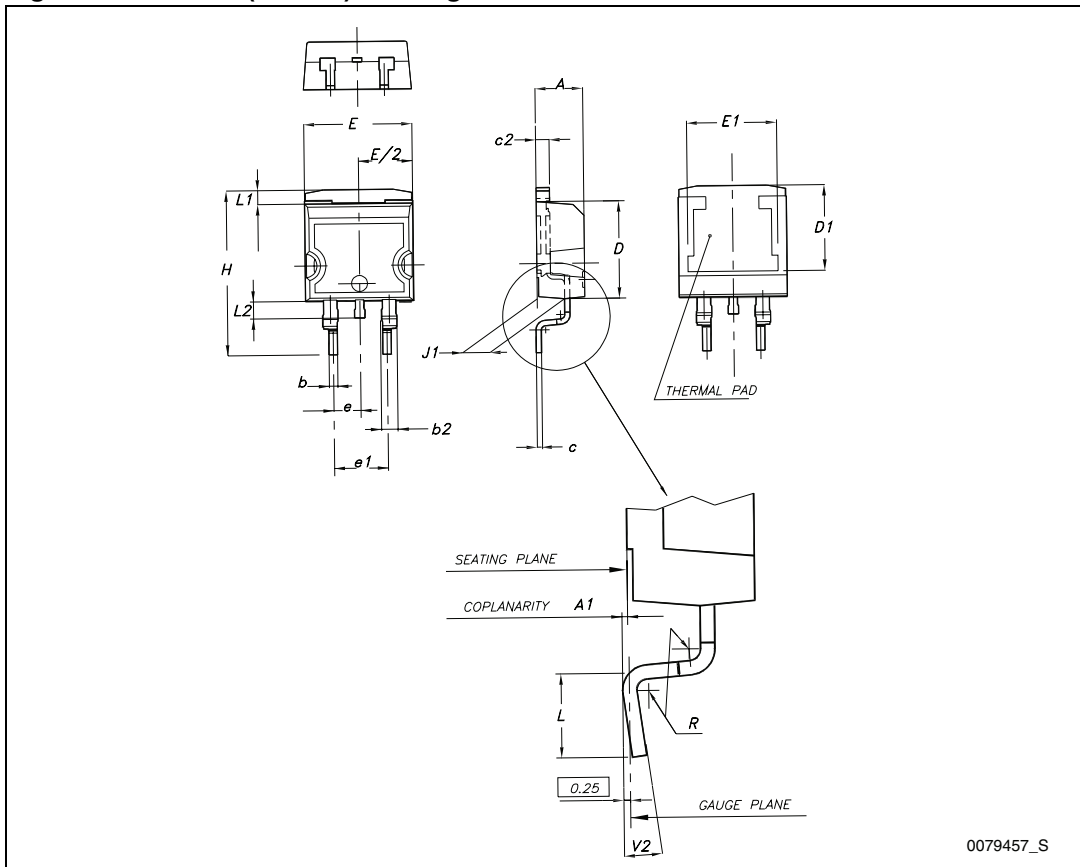
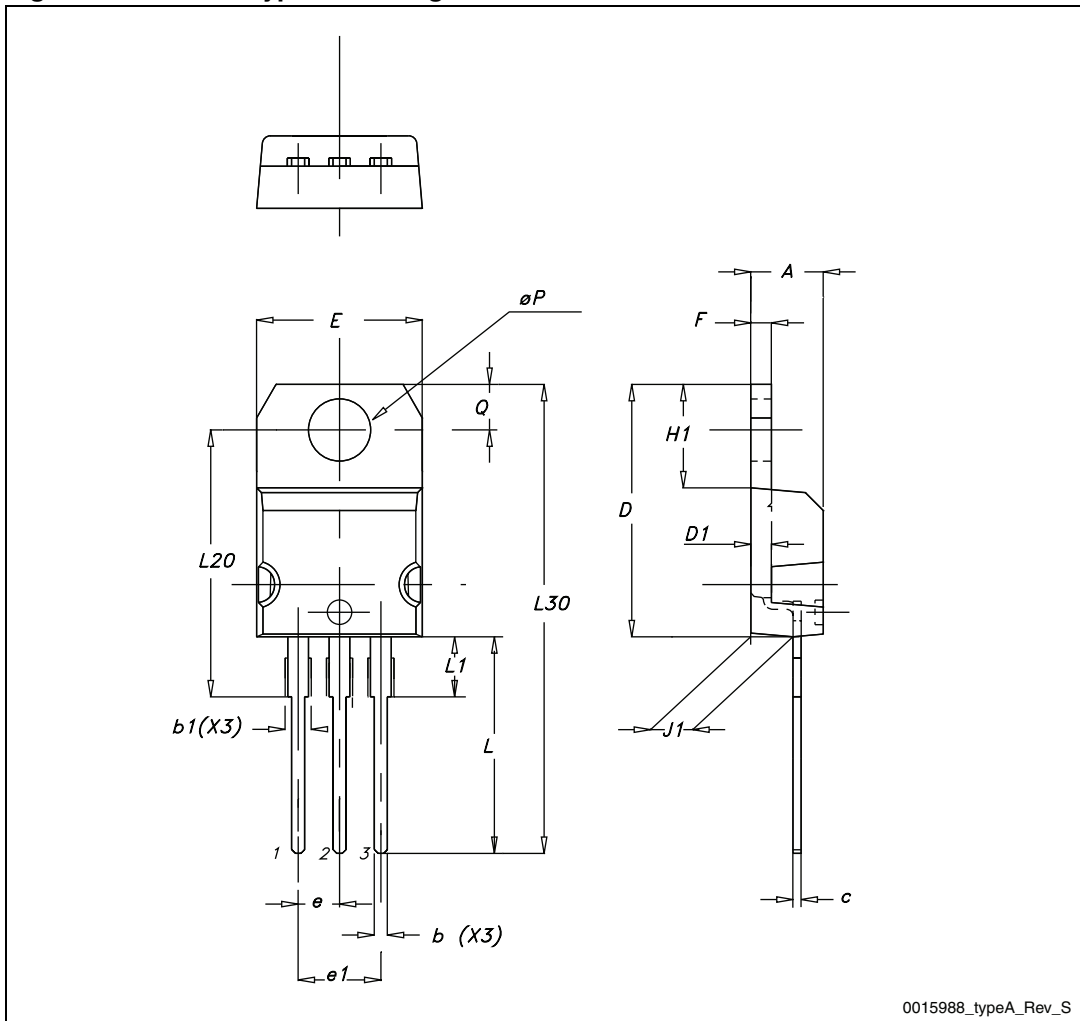


Table 9. TO-220 type A mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
∅P	3.75		3.85
Q	2.65		2.95

Figure 20. TO-220 type A drawing



0015988\_typeA\_Rev\_S

## 5 Packaging mechanical data

Table 10. D<sup>2</sup>PAK (TO-263) tape and reel mechanical data

Tape			Reel		
Dim.	mm.		Dim.	mm.	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base qty		1000
P2	1.9	2.1	Bulk qty		1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

Figure 21. D<sup>2</sup>PAK footprint (a)

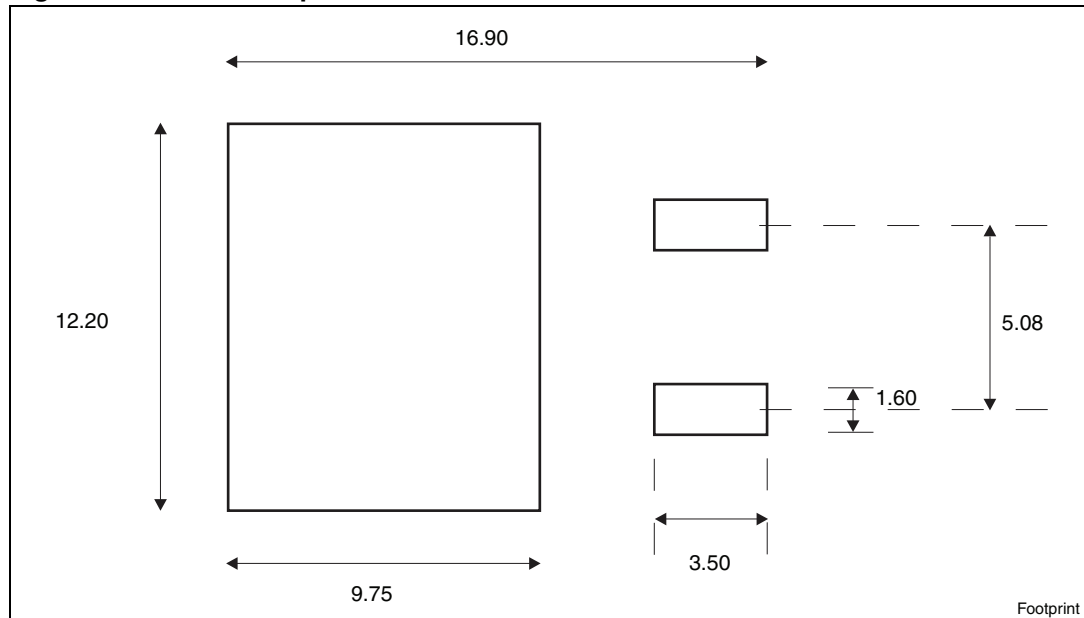
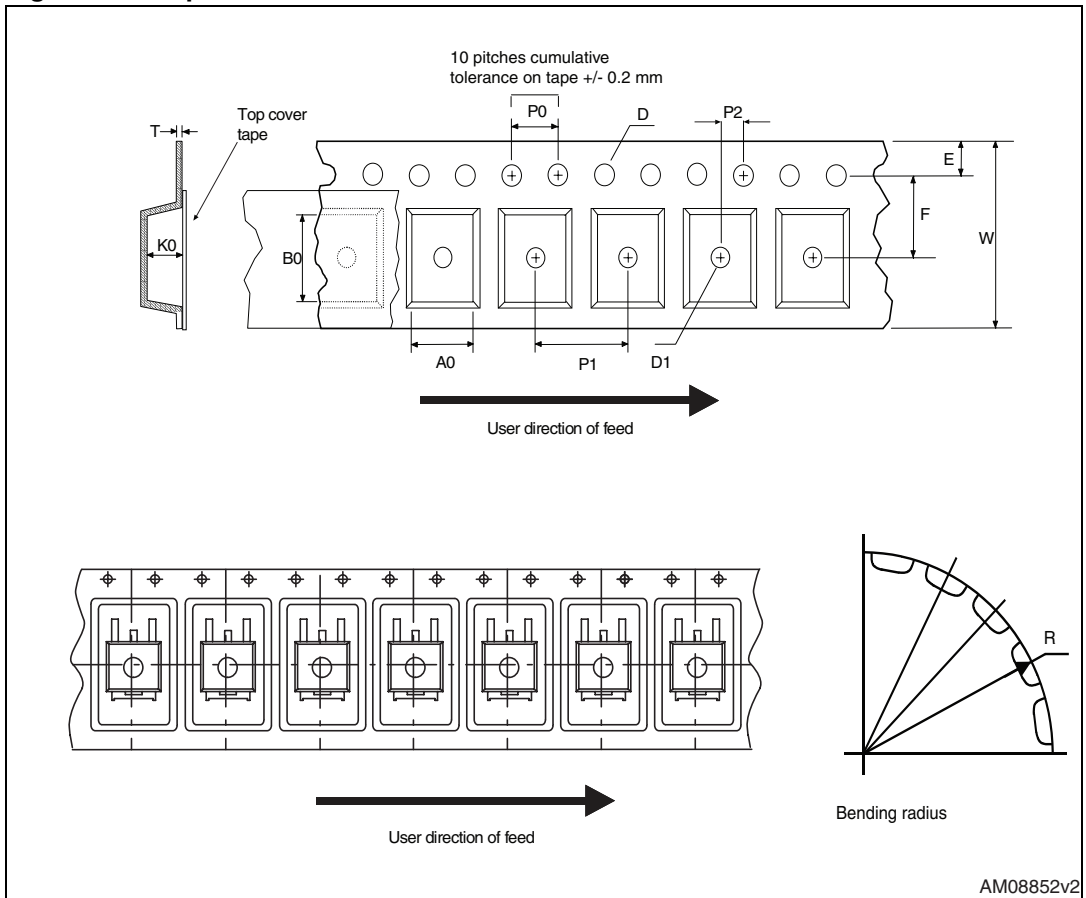


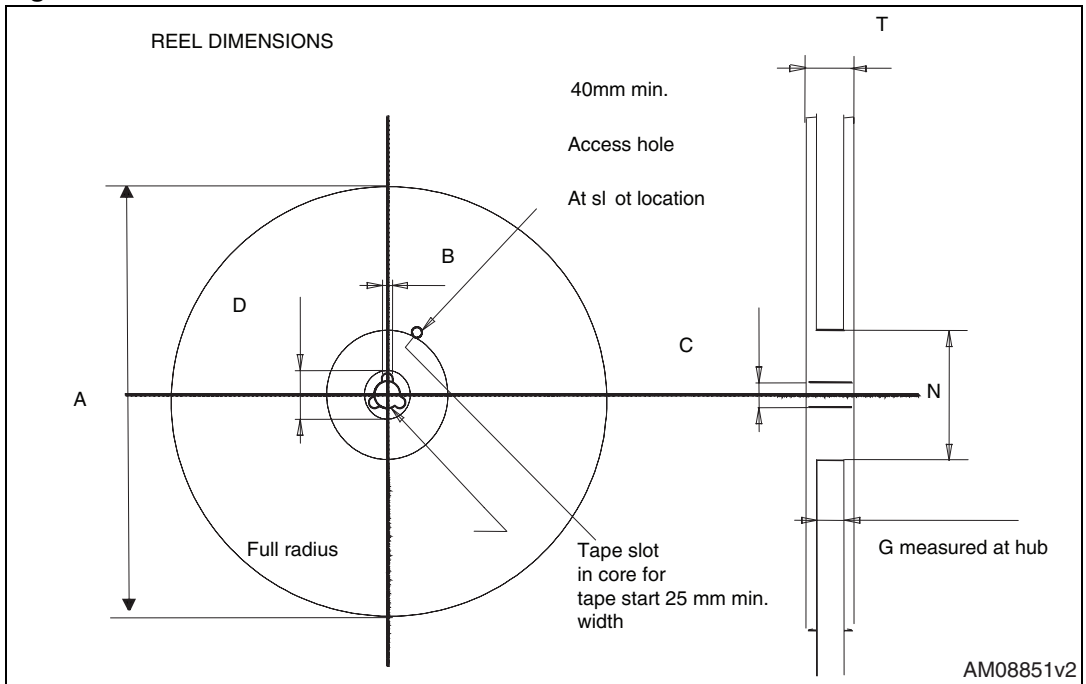
Figure 22. Tape



a. All dimension are in millimeters.



Figure 23. Reel



## 6 Revision history

**Table 11. Document revision history**

Date	Revision	Changes
10-Nov-2004	1	New release.
28-Feb-2005	2	Some values changed in <a href="#">Table 4: Static</a> .
16-Dec-2010	3	Updated <a href="#">Table 2: Absolute maximum ratings</a> . Updated mechanical data <a href="#">Section 4: Package mechanical data</a> .
27-Sep-2011	4	Modified: unit value <a href="#">Table 7 on page 5</a> , <a href="#">Figure 2 on page 6</a> and <a href="#">Figure 3 on page 6</a> . Updated mechanical data D <sup>2</sup> PAK <a href="#">Table 8 on page 11</a> and <a href="#">Figure 19 on page 12</a> . Removed order code STGP10NB60SFP and TO-220FP package mechanical data.